# A 44–93-μs 250–400-mV 0.18-μm CMOS Starter for DC-Sourced Switched-Inductor Energy Harvesters

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Abstract— Although microsystems can replenish batteries and energize modules with ambient energy without having to store much energy on board, on-chip photovoltaic cells and thermoelectric generators generate 50-400 mV, which is usually not sufficiently high to operate transistors. Even though stacking cells is possible, the tradeoff in power is ultimately unfavorable because small transducers output little power. Thankfully, transformers can boost millivolt voltages, but not without a significant toll on space. Motion-propelled MEMS switches can also start a harvester, but only in the presence of vibrations. And although 50-300-mV ring- and LC-oscillating networks can charge batteries, initialization requires 1-15 ms. The prototyped 0.18-µm CMOS oscillating starter presented here draws power from 250-450 mV to charge 100 pF to 0.32-1.55 V in 44-92 µs. In steady state, the cost of the starter to the dc-sourced harvester it supports is only a 1.8% drop in power-conversion efficiency.

*Index Terms*—Energy harvester, thermoelectric, photovoltaic, dcsourced, low-voltage starter, switched-inductor dc–dc converter.

## I. ENERGIZING WIRELESS MICROSYSTEMS

WIRELESS microsensors network together to add performance-enhancing and energy-saving intelligence to large, remote, and inaccessible places like factories, hospitals, etc. [1]–[2]. Tiny batteries, however, store insufficient energy to sustain over years the sensor, processor, and transmitter that these devices normally incorporate. This is why research is resorting to ambient sources for help. But since small transducers generate little power intermittently, the role of the harvesting source is to replenish the small on-board battery that powers the system, as Fig. 1 illustrates.

Of readily available sources like light, heat, motion, and electromagnetic radiation, sunlight generates the most power at 10–15 mW/cm<sup>3</sup> [3]. And even though artificial lighting and heat output considerably less power at 5–100  $\mu$ W/cm<sup>3</sup> [3], they are pervasive in consumer applications and mechanical systems. At the millimeter scale, however, photovoltaic (PV) cells produce 300–400 mV and thermoelectric generators (TEGs) output 50–150 mV [4], which are hardly sufficient to operate CMOS transistors. Stacking PV cells is possible, but in the case of CMOS cells and artificial lighting not without a

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substantial loss in output power [3]. And since microchips only drop 5° to 10° C, on-chip TEGs output less than 150 mV.



Fig. 1. Wireless microsystem.

With only 50–400 mV at the input and no initial charge in the battery, the conventional charger–supply in Fig. 1 can neither charge the battery nor power the system. This is why Section II of this paper proposes and Section III shows how a prototyped CMOS starter charges a capacitor that supplies start-up energy to the harvester. Section IV then assesses the performance of this technology in light of the applications it supports and the state of the art already reported in literature. Section V ends with a summary of relevant conclusions.

## II. PROPOSED SWITCHED-INDUCTOR HARVESTER

The self-starting harvesting system first proposed in [5] and now prototyped and shown in Fig. 2 uses a slightly modified starter circuit and a 100-pF capacitor  $C_{ST}$  to start the system from no-charge conditions. For this, the starter energizes and drains an inductor  $L_X$  in alternating cycles from the input  $v_H$ into  $C_{ST}$ . When  $C_{ST}$  holds enough energy to operate the boost dc–dc converter that the controller and switches  $S_E$  and  $S_B$ realize, the controller shuts the starter and commands  $S_E$  and  $S_B$  to transfer input power from  $v_H$  to the battery  $C_{BAT}$ .



# A. Oscillating CMOS Starter

 $L_X$  and the starter in Fig. 3 comprise an LC oscillator.  $M_{SEN}$  is a JFET in [5] and a low-threshold (200 mV) NFET here to remove the need for a JFET. To understand the circuit, consider that, without a harvesting source, all node voltages are 0 V. When  $v_H$  first rises above  $M_{SEN}$ 's threshold voltage,  $M_{SEN}$  conducts and  $v_H$  energizes  $L_X$  and capacitor  $C_S$  across  $t_E$ 

in Fig. 4. When  $C_S$ 's  $v_S$  rises enough to weaken  $M_{SEN}$ 's conduction,  $L_X$ 's excess current charges parasitic capacitance  $C_{SW}$  at switching node  $v_{SW}$  until diode-connected and gate-grounded PFETs  $M_{PD}$  and  $M_{P0}$  conduct to drain  $L_X$  into  $C_{ST}$ . So across  $L_X$ 's first de-energizing period  $t_D$ ,  $v_{SW}$  reaches roughly 400 mV and  $C_{ST}$ 's  $v_{ST}$  begins to rise.  $v_{ST}$  continues to rise with every cycle until  $C_{ST}$  has enough energy to operate the controller in Fig. 2. At that point, at 38 µs in Fig. 4, when  $v_{ST}$  is 0.5 V, the controller raises  $v_{OFF}$  to shut the starter.



The purpose of  $M_{PDLY1}$ ,  $M_{PDLY2}$ ,  $M_{NR}$ ,  $R_{DLY}$ ,  $R_G$ , and  $C_{DLY}$  is to prompt the system to start another energizing sequence. For this,  $M_{PDLY1}$  and  $M_{PDLY2}$  also draw power from  $L_X$  across each de-energizing period  $t_D$ , but not to the same extent as  $M_{PD}$  and  $M_{P0}$  because the impedance across  $M_{PDLY1}$ ,  $M_{PDLY2}$ ,  $R_{DLY}$ ,  $R_G$ , and  $M_{NR}$ 's parasitic gate capacitance  $C_{DLY}$  is higher than that of  $M_{P0}$ ,  $M_{P0}$ , and  $C_{ST}$ . Still,  $C_{DLY}$  eventually rises and closes  $M_{NR}$  after each energizing period  $t_E$  to discharge  $C_S$ . And with a lower voltage at  $v_S$ ,  $M_{SEN}$  conducts more current to energize  $L_X$  and  $C_S$  from  $v_H$ . Then, as  $v_S$  rises across another  $t_E$ ,  $M_{SEN}$ weakens and  $L_X$  again drains into  $C_{SW}$ ,  $C_{ST}$ , and  $C_{DLY}$  to repeat the sequence. The purpose of  $R_G$  in all this is to drain  $C_{DLY}$ and open  $M_{NR}$  before the end of each energizing period  $t_E$ .

 $M_{SEN}$ ,  $M_{PDLYI}$ - $M_{PDL2}$ ,  $R_{DLY}$ , and  $M_{NR}$  enclose a positive feedback loop that oscillates.  $L_X$  energizes from  $v_H$  when  $M_{SEN}$ 's conduction is strong and drains into  $C_{SW}$ ,  $C_{ST}$ , and  $C_{DLY}$  when  $M_{SEN}$ 's conduction is weak.  $C_S$  delays the energizing period and  $C_{DLY}$  the drain period to ensure  $L_X$ draws and delivers sufficient energy from  $v_H$  to  $C_{ST}$ . Since  $M_{SEN}$ 's resistance is low,  $v_H$  energizes  $L_X$ ,  $C_S$ , and  $C_{SW}$  in roughly a quarter cycle of  $L_X$ ,  $C_S$ , and  $C_{SW}$ 's resonance period:

$$t_{\rm E} \approx \frac{t_{\rm LC}}{4} = \frac{2\pi}{4} \sqrt{L_{\rm X} \left( C_{\rm S} + C_{\rm SW} \right)} \,. \tag{1}$$

Afterwards,  $L_X$  partially drains into  $C_{SW}$ , and then into  $C_{ST}$  and  $C_{DLY}$  as long as  $M_{NR}$  remains open, that is, as long as  $C_{DLY}$  draws current from  $R_{DLY}$  and  $R_G$  to close  $M_{NR}$ .

 $M_{PDLY1}$  and  $M_{PDLY2}$  (which were one PFET in [5]) are connected in series to keep either body diode from activating when configured to be off.  $M_{SEN}$  is a low-threshold NFET because its gate voltage is  $v_{H}$ , which is low. The purpose of  $M_{P0}$  and its grounded gate is to set the voltage at  $v_{SW}$  above which  $L_X$  starts draining into  $C_{ST}$ . This way,  $M_{PD}$  and  $M_{P0}$  do not conduct into  $C_{ST}$  until  $v_{SW}$  rises above  $M_{PD}$ 's and  $M_{P0}$ 's two source–gate voltages  $2v_{SGP}$ . This is important when the startup process begins because  $C_{ST}$ 's  $v_{ST}$  is zero and  $M_{PD}$  without  $M_{P0}$ would start draining  $L_X$  when  $v_{SW}$  reaches  $v_{SGP}$ . And since  $C_{DLY}$ 's  $v_{DLY}$  is a voltage-divided impression of  $v_{SW}$ ,  $v_{SGP}$  at  $v_{SW}$ is not high enough to raise  $v_{DLY}$  above  $M_{NR}$ 's zero-bias threshold  $V_{TN0}$ .

# B. Design Considerations

<u>Minimum Gate Drive</u>: To start energizing  $L_X$ ,  $M_{SEN}$  must conduct current. For this,  $M_{SEN}$ 's gate voltage  $v_H$  must first surpass  $M_{SEN}$ 's threshold voltage  $v_{TN(SEN)}$ .

$$V_{\rm H} > V_{\rm TN(SEN)}$$
 (2)

This is why M<sub>SEN</sub> is a low-threshold transistor.

<u>Gate-Drive Degeneration</u>: To start draining  $L_X$ ,  $M_{SEN}$ 's current  $i_{SEN}$  must fall below  $L_X$ 's built-up current  $i_L$ . But since  $L_X$  energizes as long as  $v_H$  is greater than  $v_{SW}$ ,  $i_L$  does not stop rising until  $v_{SW}$  reaches  $v_H$ . At this point,  $i_{SEN}$  must be lower than  $i_L$  for what remains of  $i_L$  to charge  $C_{SW}$  and raise  $v_{SW}$  to the point  $i_L$  can also charge  $C_{ST}$  and  $C_{DLY}$ . For this,  $i_{SEN}$  must charge  $C_S$  enough for  $v_S$  to collapse  $M_{SEN}$ 's gate drive. And since  $M_{SEN}$ 's bulk terminal is at ground in Fig. 3, raising  $v_S$  increases  $M_{SEN}$ 's threshold voltage  $v_{TN}$ , which means bulk effects further degenerate  $M_{SEN}$ 's capacitance should be low. But  $C_S$  should also be high enough to extend the energizing period  $t_E$  to the point  $L_X$  draws sufficient energy from  $v_H$  to then charge  $C_{SW}$ ,  $C_{ST}$ , and  $C_{DLY}$ .

<u>*Minimum Input Energy*</u>: Across each energizing period t<sub>E</sub>, M<sub>SEN</sub> consumes power and C<sub>SW</sub> and C<sub>S</sub> draw energy from v<sub>H</sub>. So for L<sub>X</sub> to hold energy at the end of t<sub>E</sub>, v<sub>H</sub> must supply with  $E_{H(E)}$  more energy than C<sub>SW</sub>, C<sub>S</sub>, and M<sub>SEN</sub> require with  $E_{SW(E)}$ ,  $E_{S(E)}$ , and  $E_{SEN(E)}$ :

$$E_{H(E)} > E_{SW(E)} + E_{S(E)} + E_{SEN(E)}$$
 (3)

To finish the first energizing event,  $v_H$  must charge  $C_{SW}$  from zero to  $v_H$ , so  $E_{SW1(E)}$  is

$$E_{SW1(E)} = 0.5 C_{SW} v_{H}^{2}.$$
 (4)

 $v_H$  must similarly charge  $C_S$  across  $\Delta v_S$ , enough to weaken  $M_{SEN}$ 's  $i_{SEN}$  below  $L_X$ 's  $i_L$ , so  $E_{S(E)}$  is

$$E_{S(E)} = 0.5 C_s \Delta v_s^2 .$$
 (5)

But to charge  $C_{SW}$  to  $v_H$  and  $C_S$  across  $\Delta v_S$  with  $q_H$ ,  $v_H$  must supply with the first energizing event

$$\mathbf{E}_{\mathrm{HI}(\mathrm{E})} = \mathbf{q}_{\mathrm{H}} \mathbf{v}_{\mathrm{H}} = \left( \mathbf{C}_{\mathrm{SW}} \mathbf{v}_{\mathrm{H}} + \mathbf{C}_{\mathrm{S}} \Delta \mathbf{v}_{\mathrm{S}} \right) \mathbf{v}_{\mathrm{H}} \,. \tag{6}$$

In other words,  $v_H$  must be high enough for  $E_{H(E)}$  to not only charge  $C_{SW}$  and  $C_S$  but also supply  $M_{SEN}$ 's consumption. This is why  $M_{PD}$  and  $M_{P0}$  are small, to keep  $C_{SW}$  and its uncollectable energy low.

Sustaining Oscillations: For oscillations to persist, M<sub>NR</sub>'s gate voltage v<sub>DLY</sub> must rise high enough after each energizing period  $t_E$  to reset  $M_{NR}$  and start another energizing event. Plus, v<sub>DLY</sub> must reach its target before L<sub>X</sub> exhausts its energy because L<sub>X</sub> would otherwise stop charging C<sub>DLY</sub> before M<sub>NR</sub> can reset. In other words, v<sub>DLY</sub>'s delay t<sub>DLY</sub> must be shorter than  $L_X$ 's exhaust time  $t_{EX}$  when drained across  $v_H$  and  $v_{SW}$ :

$$t_{DLY} < t_{EX} = L_X \left( \frac{\Delta i_L}{\Delta v_L} \right) = L_X \left( \frac{\Delta i_L}{v_{SW} - v_H} \right).$$
(7)

For this,  $L_X$  first charges  $C_{SW}$  across  $\Delta v_{SW}$ , and  $v_{DLY}$  then follows after M<sub>PDLY1</sub> and M<sub>PDLY2</sub> short and L<sub>X</sub> charges C<sub>DLY</sub> via R<sub>DLY</sub> and R<sub>G</sub>. v<sub>DLY</sub> therefore reaches 90% of the voltagedivided fraction of  $v_{SW}$  that  $R_{DLY}$  and  $R_G$  set after roughly 2.3 RC time constants  $t_{RC}$ :

$$\Delta v_{DLY} \approx v_{SW} \left( \frac{R_G}{R_{DLY} + R_G} \right) \left[ 1 - e^{-\left( \frac{t_{DLY}}{t_{RC}} \right)} \right], \quad (8)$$

where  $M_{PDLY1}$ - $M_{PDLY2}$ 's resistance is much lower than  $R_{DLY}$ and  $t_{RC}$  is, in consequence,  $R_{DLY} || R_G$  and  $C_{DLY}$ 's time constant:

$$t_{\rm DLY} \approx 2.3 t_{\rm RC} \approx 2.3 (R_{\rm DLY} \parallel R_{\rm G}) C_{\rm DLY} \,. \tag{9}$$

Since  $M_{NR}$  resets the system before  $v_{DLY}$  can reach 100% of  $v_{SW}$ 's voltage-divided fraction,  $t_{DLY}$  is about 2.3 $t_{RC}$ .

When the system first starts, C<sub>SW</sub> must charge from zero to M<sub>PD</sub> and M<sub>P0</sub>'s two source-gate voltages 2v<sub>SGP</sub>, so L<sub>X</sub> drains when its terminal voltages are roughly  $v_H$  and  $2v_{SGP}$ .  $v_{DLY}$ must then rise above  $M_{NR}$ 's zero-bias threshold voltage  $V_{TN0}$ for M<sub>NR</sub> to engage. This means, the voltage-divided fraction  $R_{DLY}$  and  $R_G$  set from  $v_{SW}$ 's  $2v_{SGP}$  must be greater than  $V_{TN0}$ :

$$2v_{SGP}\left(\frac{R_{G}}{R_{DLY}+R_{G}}\right) > V_{TN0}, \qquad (10)$$

and  $v_{DLY}$  must rise above  $V_{TN0}$  across  $t_{DLY}$  before  $L_X$  depletes at  $t_{EX}$  when drained with  $2v_{SGP} - v_{H}$ .

 $M_{NR}$  should then reset  $M_{SEN}$  across  $t_{RES}$  before  $R_{G}$ discharges C<sub>DLY</sub> across t<sub>DIS</sub>:

$$\mathbf{t}_{\text{RES}} \approx 2.3 \mathbf{C}_{\text{S}} \left( \mathbf{R}_{\text{SEN}} \parallel \mathbf{R}_{\text{NR}} \right) < \mathbf{t}_{\text{DIS}} , \qquad (11)$$

where  $R_{SEN}$  and  $R_{NR}$  are  $M_{SEN}$  and  $M_{NR}$ 's resistances and  $t_{RES}$  is roughly 2.3 time constants of C<sub>s</sub>, R<sub>SEN</sub>, and R<sub>NR</sub>. And R<sub>G</sub> should drain C<sub>DLY</sub> before the energizing event ends. So about 2.3 time constants of  $R_G$  and  $C_{DLY}$  must elapse before  $t_E$ :

$$t_{\rm DIS} \approx 2.3 R_{\rm G} C_{\rm DLY} < t_{\rm E} \,. \tag{12}$$

# III. MEASURED PERFORMANCE

The 600  $\times$  250-µm<sup>2</sup> 0.18-µm CMOS die in Fig. 5b integrates the oscillating starter in Fig. 3, the startup capacitor  $C_{ST}$  in Figs. 2–3 and 5a, and the power transistors  $M_E$  and  $M_{B1}$ - $M_{B2}$  in Fig. 5a. The printed circuit board (PCB) in Fig. 5c embeds the fabricated microchip, the 100- $\mu$ H inductor L<sub>X</sub> in Figs. 2–3 and 5a, the controller in Figs. 2 and 5a, the 100-nF battery C<sub>BAT</sub> in Figs. 2 and 5a, and test circuits used to evaluate the system. Operationally, the starter charges C<sub>ST</sub> until  $C_{ST}$  stores enough energy for the controller to operate  $M_E$ and M<sub>B1</sub>. Afterwards, M<sub>E</sub> energizes L<sub>X</sub> from the harvesting source  $v_{\rm H}$  and  $M_{\rm B1}$ - $M_{\rm B2}$  drains  $L_{\rm X}$  into  $C_{\rm BAT}$  in alternating cycles. The purpose of the diode-connected transistor  $M_{B2}$  is to block reverse battery current that would otherwise drain C<sub>BAT</sub>. Here, the converter that M<sub>E</sub>, M<sub>B1</sub>, M<sub>B2</sub>, and the controller realize is for test purposes only, to show how the starter affects the dc-sourced harvester it supports.



Fig. 5. Prototyped harvesting system, die, and board.

## A. Starter

As Fig. 4 demonstrates, the starter energizes and drains  $L_X$ in alternating cycles when  $v_H$  rises to 300 mV to charge  $C_{ST}$  to 500 mV in 38  $\mu s.$  The system starts as long as  $v_{\rm H}$  ramps to its target within 300 ns, before L<sub>X</sub>, C<sub>S</sub>, and C<sub>SW</sub> have a chance to drain with resonance. The oscillator starts without the poweron-reset transistor and signal that [5] needs. Oscillations persist as long as  $v_H$  is at or above 255 mV, as Fig. 6 shows.



Fig. 6. Measured starter waveforms when C<sub>ST</sub> is a pre-charged battery.

Notice in Fig. 4 that the system stops charging C<sub>ST</sub>'s 100 pF at 500 mV. This happens because L<sub>X</sub> first energizes more than it drains to build current i<sub>L</sub> in L<sub>X</sub>, but later drains more than it receives to collapse  $i_L$ . So when connected to a drained  $C_{ST}$ , 250 and 450 mV at  $v_H$  can charge  $C_{ST}$  to 320 mV and 1.55 V, respectively, as Fig. 7 shows. This means, the system charges  $C_{\text{ST}},$  but only to the extent that  $v_{\text{H}}$  allows. This relationship is nearly independent of C<sub>ST</sub>, as Fig. 8 further shows, with only a  $\pm 2.5\%$  variation across 0.1–1.6 nF. So irrespective of the energy needed to charge CST, the effective gain of the system from  $v_H$  to  $C_{ST}$ 's final voltage  $V_{ST(F)}$  is 1.28–3.47 V/V.

Since  $V_{ST(F)}$  depends on  $v_H$ , but not on  $C_{ST}$ , the startup time  $t_{ST}$  that the system requires to charge  $C_{ST}$  to  $V_{ST(F)}$  climbs with  $v_{\rm H}$  and  $C_{\rm ST}$ . This is why  $t_{\rm ST}$  in Figs. 9 and 10 spans 44–93  $\mu$ s for 250–450 mV at  $v_H$  and 64–783 µs for 0.1–1.6 nF. Through this time,  $C_{ST}$  receives 0.15% to 0.65% of the energy that  $v_{H}$ sources. Power-conversion efficiency across startup is low because the system lacks the gate drive necessary to keep

Ohmic losses low. With lower losses,  $L_X$  would have been able to draw and deliver more power.



#### B. Harvesting System

Although  $C_{ST}$ 's  $v_{ST}$  in Fig. 9 climbs to 830 mV in 53  $\mu$ s, the controller in Fig. 5a interrupts the startup process with  $v_{OFF}$  when  $v_{ST}$  surpasses its headroom limit, which in the example of Fig. 5a is 0.7 V, after 41  $\mu$ s of  $t_{STRT}$  in Fig. 11. With 0.7 V across  $C_{ST}$ , the controller closes  $M_E$ , and as a result, energizes  $L_X$  from  $v_H$  via a low-resistance switch. This way,  $L_X$  draws more energy from  $v_H$ , so when  $M_E$  opens,  $M_{PD}$  and  $M_{P0}$  in the starter of Fig. 3 steer  $L_X$ 's  $i_L$  into  $C_{ST}$  to raise  $v_{ST}$  another 0.3 V after only one cycle, at 46  $\mu$ s. After that, the controller closes  $M_E$  and  $M_{B1}$  in alternating cycles to energize and drain  $L_X$  into  $C_{BAT}$ . So after three cycles at 62.5 kHz in steady state, the voltage across  $C_{BAT}$ 's 100 nF rises 210 mV.

Without the starter and in steady state,  $M_E$  and  $M_{B1}$ – $M_{B2}$  in Fig. 5a charge  $C_{BAT}$  with 62% to 74% of the 10–160  $\mu$ W that the system receives from the harvesting source  $v_H$ , as Fig. 12 shows. The cost of connecting the starter is 1.8%. The reason

for this loss is the energy lost to charging  $C_s$  and the additional capacitance that the starter adds to  $v_{SW}$ . For one,  $C_s$  partially drains  $L_x$  when  $L_x$  drains because  $M_E$  in Fig. 5a first discharges  $C_s$  through  $M_{SEN}$  in Fig. 3 when  $M_E$  energizes  $L_x$ . With  $C_s$ 's  $v_s$  nearly at 0 V,  $v_H$  closes  $M_{SEN}$  to draw current from  $L_x$  and charge  $C_s$ . Charging  $C_{SW}$  similarly draws power from  $L_x$ , which is why adding board capacitance to  $v_{SW}$  raises the loss in Fig. 12 to 3.9%. Note that, even after  $v_{OFF}$  closes  $M_{OFF}$ ,  $M_{PDLY1}$ ,  $M_{PDLY2}$ , and  $R_{DLY}$  do not dissipate much of  $L_x$ 's energy because  $C_{ST}$ 's  $v_{ST}$  keeps  $M_{PDLY1}$  and  $M_{PDLY2}$  off.



## IV. CONTEXT

One fundamental requirement for a microsensor is not to burden its host. This means, it should be small and selfpowered. And since tiny photovoltaic cells and thermoelectric generators output little power, conduction, gate-drive, quiescent, and start-related losses should be low, which is why conversion efficiency should be high [6]. But to keep startup losses at bay, startup time should also be short. So in all, the system should be small and efficient, and start quickly.

# A. The State of the Art

One way to boost the input voltage to sufficiently high levels to operate CMOS switches is with a transformer [7]–[8]. And with a low-loss transformer, the system can convert and transfer power efficiently in steady state. Unfortunately, a low-loss transformer is, in relative terms, bulky and expensive.

Although transistors powered from 300–400-mV supplies are resistive, they can still steer currents and transfer power. In fact, ring oscillators in [9]–[13] can drive CMOS transistors to switch capacitors that generate a voltage that is high enough to then energize and drain an inductor into a battery. And by tuning N- and P-channel MOS threshold voltages to balance, the network can operate with an 80-mV input [14]–[15], as Table I shows. LC oscillators can similarly operate with a 50mV supply [16]. The problem here is that resistances are so high at 50–330 mV and switched capacitors so inefficient that initializing the system requires 1.2–15 ms. Plus, the LC oscillator requires two 4- $\mu$ H inductors and tuning threshold voltages is prohibitively expensive in practice. Although the prototyped system starts from 250 mV from Fig. 7, v<sub>H</sub> in Table I is 300 mV because performance is more comparable to the state of the art when C<sub>ST</sub>'s final voltage V<sub>ST(F)</sub> is 0.55 V.

IABLEI	
RELATIVE PERFORMANC	E

	X-former [8]	<b>Ring Oscillator</b>		LC	MEMS	This	
		[12]	Tuned [15]	Osc. [16]	[4]	Work	
V <sub>H(MIN)</sub>	40 mV	330 mV	80 mV	50 mV	35 mV	0.3 V	
t <sub>INI</sub>	-		2.4 ms	15 ms	-	-	
t <sub>st</sub>	2 s	1.2 s	+500 μs	+100 µs	t <sub>VIB</sub>	44 µs	
V <sub>ST(F)</sub>	1.2 V	1.8 V	1.3 V	0.8 V	1 V	0.55 V	
Cst	10 µF	10		10 mE	4.7 nF	470 pF	100 pF
CBAT			10 nF	1 µF	100 nF	100 nF	
Extra	X-former & 30 pF		132 pF	$2 \times 4 \ \mu \mathrm{H}$	MEMS	32 pF	

In [4], motion opens and closes an electromechanical MEMS switch that energizes and drains an inductor into 470 pF until the capacitor's voltage is high enough to drive a CMOS transistor. Since motion drives the MEMS device, the system can start from a 35-mV input. The drawback here is motion, because vibrations are not always available, and when they are, the period is long, so starting the system can require 3–20 ms. Plus, the switching interruptions that motion causes in steady state reduce how much power the system can output.

The benefits of the technology presented here are size, cost, and speed. For the first two, the entire starter can be on chip, and the efficiency sacrificed in steady state for this feature is only 1.8%. And lastly, startup time is within 100  $\mu$ s. One limitation of this technology is that the harvesting source must rise within 300 ns for the system to start, which is not always possible. The voltage of the input source also limits the starter's final voltage. These restrictions, however, are not necessarily insurmountable, and research is ongoing. Plus, fast start-up applications are emerging, like when office lights or car headlights first shine on a miniaturized photovoltaic cell.

# V. CONCLUSIONS

The prototyped 0.18- $\mu$ m CMOS starter built, tested, and presented here charges 100 pF to 0.32–1.55 V from 250–450mV sources in 44–93  $\mu$ s. The starter reduces the steady-state power-conversion efficiency of the harvester it supports by only 1.8%. Although functionality and output voltage depend on the input, 350 mV can still generate 830 mV, which is high enough to operate a CMOS harvester with reasonable efficacy. This is important because tiny photovoltaic cells and thermoelectric generators output only 50–400 mV, which is not enough to drive and energize a wireless microsensor.

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